

DERWENT ABSTRACT FOR: JP 11-060836 (Asahi), published 5 Mar 1999:

L2 ANSWER 2 OF 14 WPIINDEX COPYRIGHT 2001 DERWENT INFORMATION LTD

ACCESSION NUMBER: 1999-232740 [20] WPIINDEX

DOC. NO. CPI C1999-063695

TITLE: Impact resistant resin composition for electrical/electronic component - comprises polypropylene resin, polyphenylene ether resin and hydrogenated block copolymer..

DERWENT CLASS: A17 A25

PATENT ASSIGNEE(S): (ASAHI) ASAHI KASEI KOGYO KK

COUNTRY COUNT: 1

PATENT INFORMATION

PATENT NO	KIND	DATE	WEEK	LA	PG
JP 11060836	A	19990305 (199920)*		8	<--

APPLICATION DETAILS:

PATENT NO	KIND	APPLICATION	DATE
JP 11060836	A	JP 1997-218705	19970813

PRIORITY APPLN. INFO: JP 1997-218705 19970813

AN 1999-232740 [20] WPIINDEX

AB JP 11060836 A UPAB: 19990525

A resin composition includes (a) 45 - 95 wt. % of a polypropylene resin, (b) 55 - 5 wt. % of polyphenylene ether resin, (c) 1 - 30 pt. wt to 100 pt. wt in total, of (a) and (b), of a hydrogenated block copolymer prepared by hydrogenating a block copolymer composed of at least one polymer block B mainly composed of conjugate diene compound including 30 - 90 % in total of 1, 2-vinyl bond and 3, 4-vinyl bond of conjugate diene, and at least one polymer block A mainly composed of a vinyl aromatic compound, and (d) 1 - 400 pt. wt to 100 pt. wt of (b), of rubber reinforcement impact-proof polystyrene resin having 0.14 - 0.70 micron m of average diameter of rubber dispersion particles.

USE - Effectively used in the electric and electronic components, office equipment housing, automobile components, precision components, and various industrial components.

ADVANTAGE - The resin composition superior in the impact resistance can be prepared.

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